

MC Series - TO-92



Agency Approvals

Agency	Agency File Number
	E133083

Pinout Designation



Schematic Symbol



Description

The MC Series TO-92 are low capacitance SIDACtor® thyristors designed to protect broadband CPE equipment such as VoIP and DSL Modems from damaging overvoltage transients.

The series provides a through-hole solution that enables CPE equipment to comply with global regulatory standards while limiting the impact to broadband signals.

Features and Benefits

- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit
- Fails short circuit when surged in excess of ratings
- RoHS Compliant
- 40% lower capacitance than our Baseband Protectors, for applications that demand greater signal integrity
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21/45 Enhanced Level
- ITU K.20/21/45 Basic Level
- GR 1089 Intra-building
- IEC 61000-4-5 2nd edition
- YD/T 1082
- YD/T 993
- YD/T 950
- GR 1089 Inter-building

Electrical Characteristics

Part Number	Marking	V_{DRM} @ $I_{DRM} = 5\mu A$	V_S @ $100V/\mu s$	I_H	I_S	I_T	V_T @ $I_T = 2.2$ Amps	Capacitance @ 1MHz, 2V bias	
		V min	V max	mA min	mA max	A max	V max	pF min	pF max
P0080ECMCLxxx	P0080ECMC	6	25	50	800	2.2	4	35	75
P0300ECMCLxxx	P0300ECMC	25	40	50	800	2.2	4	25	45
P0640ECMCLxxx	P0640ECMC	58	77	150	800	2.2	4	55	85
P0720ECMCLxxx	P0720ECMC	65	88	150	800	2.2	4	50	75
P0900ECMCLxxx	P0900ECMC	75	98	150	800	2.2	4	45	70
P1100ECMCLxxx	P1100ECMC	90	130	150	800	2.2	4	45	70
P1300ECMCLxxx	P1300ECMC	120	160	150	800	2.2	4	40	60
P1500ECMCLxxx	P1500ECMC	140	180	150	800	2.2	4	35	55
P1800ECMCLxxx	P1800ECMC	170	220	150	800	2.2	4	35	50
P2300ECMCLxxx	P2300ECMC	190	260	150	800	2.2	4	30	50
P2600ECMCLxxx	P2600ECMC	220	300	150	800	2.2	4	30	45
P3100ECMCLxxx	P3100ECMC	275	350	150	800	2.2	4	30	45
P3500ECMCLxxx	P3500ECMC	320	400	150	800	2.2	4	25	40

Notes:
 - Absolute maximum ratings measured at $T_A = 25^\circ C$ (unless otherwise noted).
 - Components are bi-directional.
 - **XXX** Part Number Suffix: 'AP' (Ammo Pack), or 'RP1' or 'RP2' (Reel Pack).

Surge Ratings

Series	I_{PP}									I_{TSM} 50/60 Hz	di/dt
	0.2/310 ¹	2/10 ¹	8/20 ¹	10/160 ¹	10/560 ¹	5/320 ¹	10/360 ¹	10/1000 ¹	5/310 ¹		
	0.5/700 ²	2/10 ²	1.2/50 ²	10/160 ²	10/560 ²	9/720 ²	10/360 ²	10/1000 ²	10/700 ²		
	A min	A min	A min	A min	A min	A min	A min	A min	A min	A min	A/μs Max
C	50	500	400	200	150	200	175	100	200	30	500

Notes:

- 1 Current waveform in μs
- 2 Voltage waveform in μs

- Peak pulse current rating (I_{pp}) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.
- I_{pp} ratings applicable over temperature range of -40°C to +85°C
- The component must initially be in thermal equilibrium with -40°C ≤ T_J ≤ +150°C

Thermal Considerations

Package	Symbol	Parameter	Value	Unit
 TO-92	T_J	Operating Junction Temperature Range	-40 to +150	°C
	T_S	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	90	°C/W

V-I Characteristics



$t_r \times t_d$ Pulse Waveform



Normalized V_S Change vs. Junction Temperature



Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

Reflow Condition		Pb-Free assembly (see Fig. 1)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max ($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (LiquidusTemp (T_L) to peak)		3°C/sec. Max.
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	-Temperature (T_L) (Liquidus)	+217°C
	-Temperature (t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual PeakTemp (t_p)		30 secs. Max.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to Peak Temp (T_p)		8 min. Max.
Do not exceed		+260°C



Physical Specifications

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL Recognized epoxy meeting flammability classification V-0

Additional Information



Datasheet



Resources



Samples

Environmental Specifications

High Temp Voltage Blocking	80% Rated V_{DRM} (V_{AC} Peak) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104
Biased Temp & Humidity	52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1

Part Numbering



Part Marking

